

NCE N-Channel Super Trench Power MOSFET

Description

The NCEP1545G uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

Application

- ●DC/DC Converter
- •Ideal for high-frequency switching and synchronous rectification

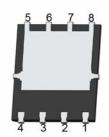
General Features

- $extstyle V_{DS}$ =150V,I $_D$ =45A $R_{DS(ON)}$ =24mΩ (typical) @ V_{GS} =10V
- ●Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- ●150 °C operating temperature
- Pb-free lead plating

100% UIS TESTED! 100% ΔVds TESTED!

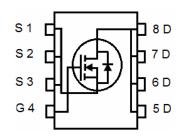
DFN 5X6





Top View

Bottom View



Schematic Diagram

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
P1545G	NCEP1545G	DFN5X6-8L	-	-	-

Absolute Maximum Ratings (T_A=25 ℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	150	V	
Gate-Source Voltage	V _{GS}	±20	V	
Drain Current-Continuous	I _D	45	Α	
Drain Current-Continuous(T _C =100℃)	I _D (100°C)	31.8	A A W	
Pulsed Drain Current	I _{DM}	180		
Maximum Power Dissipation	P _D	110		
Derating factor		0.88	W/°C	
Single pulse avalanche energy (Note 5)	E _{AS}	200	mJ	
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 150	$^{\circ}$ C	

Thermal Characteristic

Thermal Résistance, Junction-to-Case ^(Note 2)	$R_{ heta JC}$	1.14	°C/W



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Electrical Characteristics (T_A=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	150	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =150V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)			•			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2.0	3.1	4.0	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =20A	-	24	28	mΩ
Forward Transconductance	G FS	V _{DS} =5V,I _D =20A	15	-	-	S
Dynamic Characteristics (Note4)			•			
Input Capacitance	C _{lss}	==	-	1300		PF
Output Capacitance	C _{oss}	V_{DS} =75V, V_{GS} =0V, F=1.0MHz	-	162		PF
Reverse Transfer Capacitance	C _{rss}	r=1.0lvlm2	-	11.7		PF
Switching Characteristics (Note 4)			•			
Turn-on Delay Time	t _{d(on)}		-	10	-	nS
Turn-on Rise Time	t _r	V_{DD} =75 V , R_L =7.5 Ω	-	6.5	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{G} =3 Ω	-	16	-	nS
Turn-Off Fall Time	t _f		-	7	-	nS
Total Gate Charge	Qg	\/ -75\/ L -20A	-	21.1	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =75V, I_{D} =20A, V_{GS} =10V	-	8	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	4.6	-	nC
Drain-Source Diode Characteristics			•			
Diode Forward Voltage (Note 3)	V_{SD}	V _{GS} =0V,I _S =20A	-	-	1.2	V
Diode Forward Current (Note 2)			-	-	45	Α
Reverse Recovery Time	t _{rr}	$T_J = 25^{\circ}C, I_F = I_S$	-	30	-	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	135	-	nC

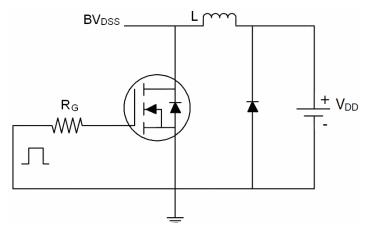
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^{\circ}\text{C}$,V $_{DD}$ =75V,V $_{G}$ =10V,L=0.5mH,Rg=25 Ω

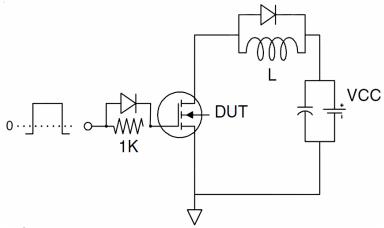


Test Circuit

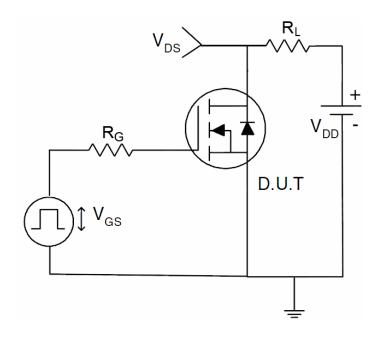
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics

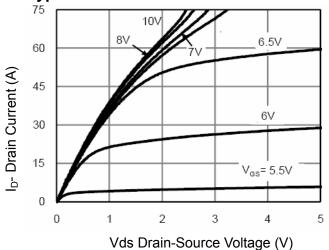


Figure 1 Output Characteristics

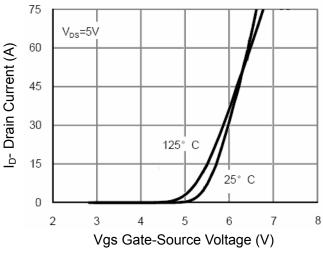


Figure 2 Transfer Characteristics

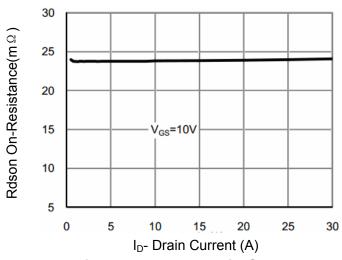


Figure 3 Rdson- Drain Current

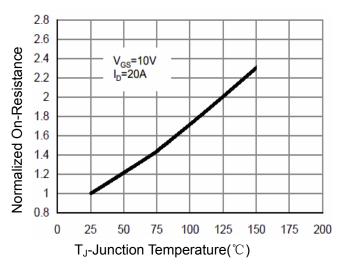


Figure 4 Rdson-Junction Temperature

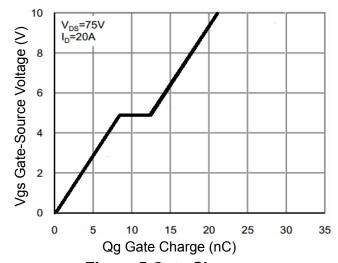


Figure 5 Gate Charge

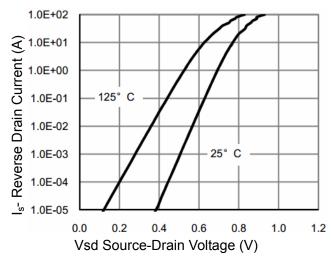
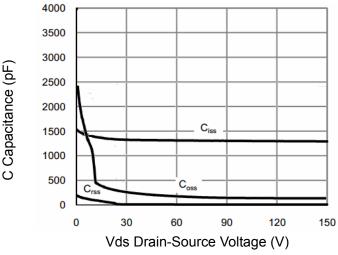


Figure 6 Source- Drain Diode Forward







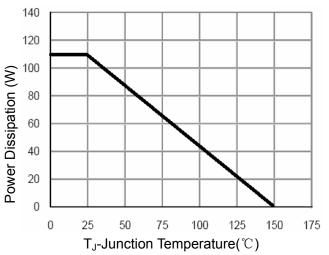


Figure 9 Power De-rating

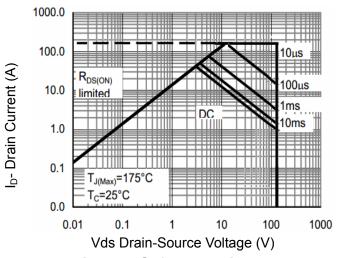


Figure 8 Safe Operation Area

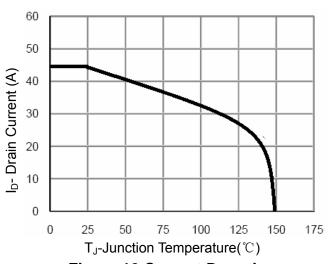


Figure 10 Current De-rating

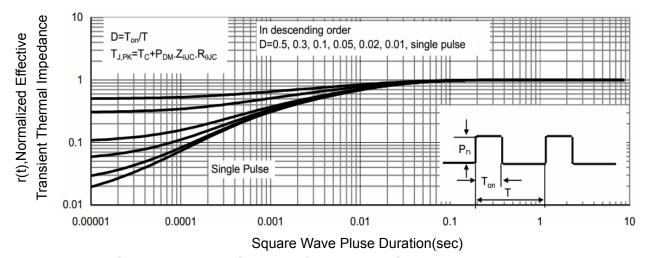
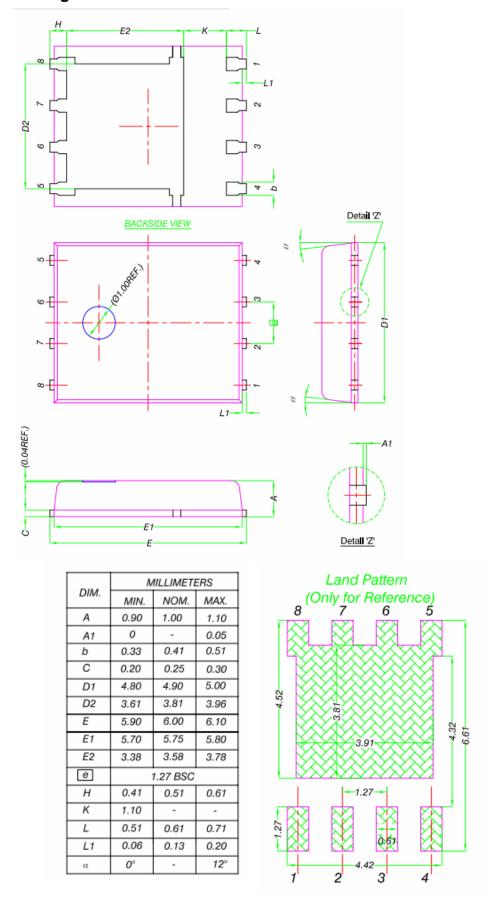


Figure 11 Normalized Maximum Transient Thermal Impedance



DFN5X6-8L Package Information





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NCEP1545G

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